

Full Color PCB Type SMD LED VAOL-S19337RGB

Features

lighting:theway

- Package in 8mm tape on a 7 " diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- RoHS compliant version.



Descriptions

- The SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density and reduced storage space and finally smaller equipment to be obtained.
- Light weight makes them ideal for miniature applications.

Applications

- Automotive.
- Portable equipment.
- General use.

Device Selection Guide

Chip			Larra Calari		
Туре	Material	Emitted Color	Lens Color		
R6	AlInGaN	Brilliant Red			
GH	InGaN	Brilliant Green	Water Clear		
BH	InGaN	Blue			



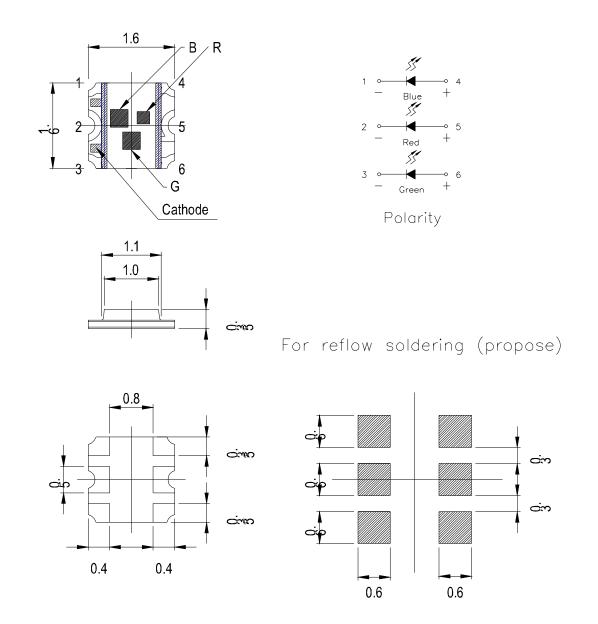




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Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm,Unit = mm







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Parameter	Symbol	Rating	Unit
Reverse Voltage	Vr	5	V
Forward Current	$\mathbf{I}_{\mathbf{F}}$	R6:25 GH:25 BH:25	mA
Operating Temperature	Topr	$-40 \sim +85$	°C
Storage Temperature	Tstg	-40 ~ +90	°C
Soldering Temperature	Tsol	260 (for 5 seconds)	°C
Electrostatic Discharge	ESD	R6:2000 GH:150 BH:150	V
Power Dissipation	Pd	R6:60 GH:110 BH:110	mW
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	R6:60 GH:100 BH:100	mA

Absolute Maximum Ratings (Ta=25°C)

Specific binning requirements- please contact our home office

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E	Clectro-Optical Cha	racteristi	ics (Ta=2	5℃)	

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Parameter	Symbol		Min.	Тур.	Max.	Unit	Condition
		R6	72	100			
Luminous Intensity	Iv	GH	112	180		mcd	
		BH	28.5	50			_
Viewing Angle	2 <i>θ</i> 1/2			120		deg	
		R6		632			
Peak Wavelength	λp	GH		518		nm	
		BH		468			_
		R6		624			
Dominant Wavelength	λd	GH		525		nm	IF=20mA
		BH		470			
		R6		20			
Spectrum Radiation Bandwidth	$ riangle \lambda$	GH		35		nm	
		BH		35			
		R6		2.0	2.4		
Forward Voltage	VF	GH		3.3	3.9	V	
		BH		3.3	3.9		
		R6			10		
Reverse Current	Ir	GH			50	μA	V _R =5V
		BH			50		

Notes:

Tolerance of Luminous Intensity ±10%
 Tolerance of Dominant Wavelength ±1nm
 Tolerance of Forward Voltage ±0.1V

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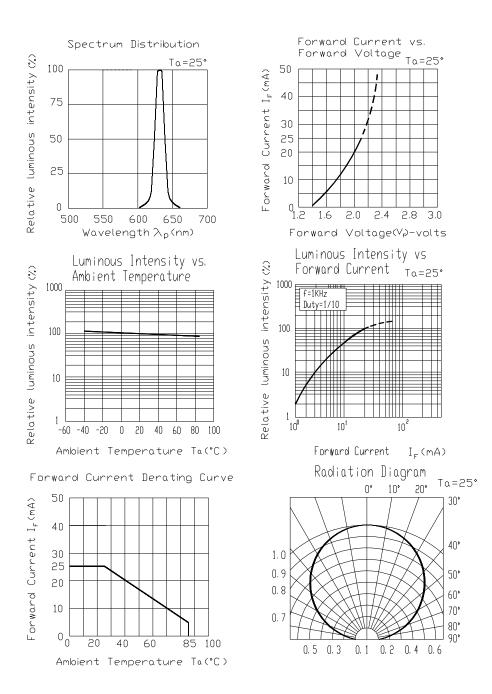


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Typical Electro-Optical Characteristics Curves

R6



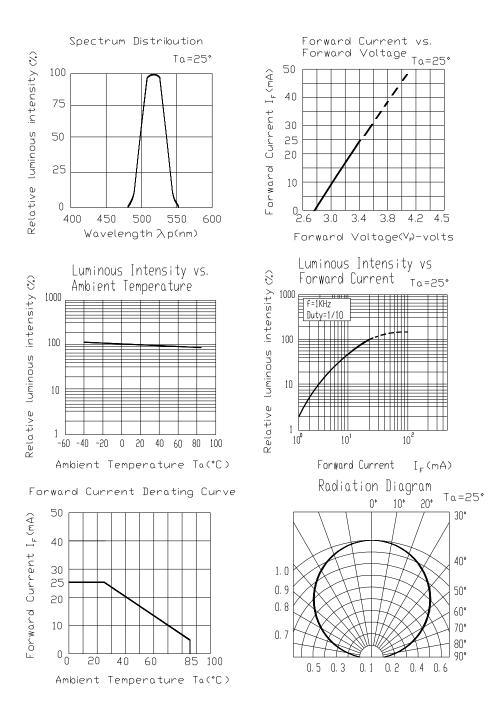






Typical Electro-Optical Characteristics Curves

GH



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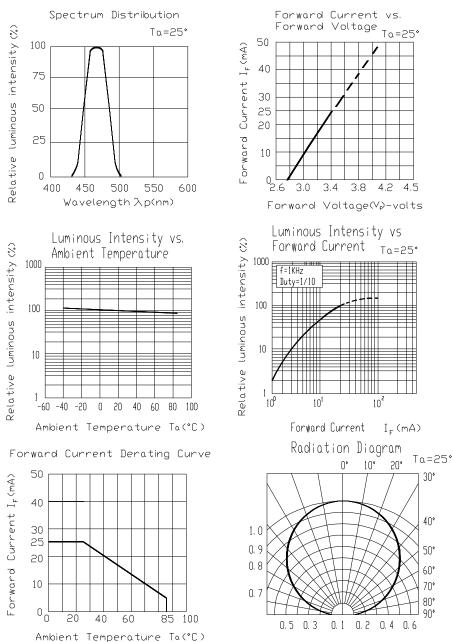
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Typical Electro-Optical Characteristics Curves

BH



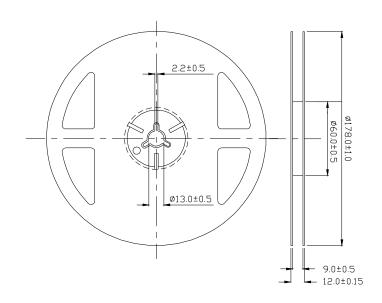








Reel Dimensions

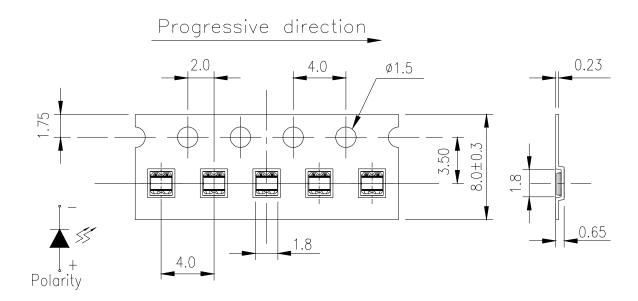


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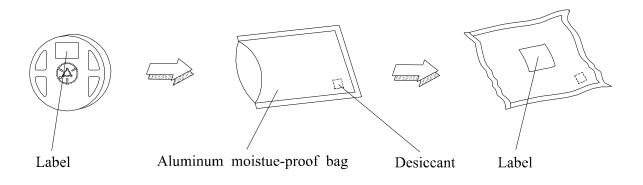




Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel

Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging











Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90% LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp . : - 40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85% RH	1000 Hrs.	22 PCS.	0/1







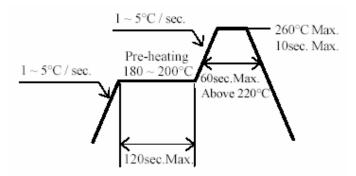
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Precautions For Use

- 1. Customer must apply resistors for protection, otherwise slight a voltage shift will cause a big current change.
- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30° C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
 Baking treatment : 60±5℃ for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

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